

## Product End-of-Life Disassembly Instructions

### Product Category: Servers

#### Marketing Name / Model

[List multiple models if applicable.]

870208-001 HPE MicroSvr Gen10 X3216 1TB Entry US Svr

870208-421 HPE MicroSvr Gen10 X3216 1TB Entry EU Svr

870208-291 HPE MicroSvr Gen10 X3216 1TB Entry JP Svr

870208-371 HPE MicroSvr Gen10 X3216 1TB Entry AP Svr

870208-AA1 HPE MicroSvr Gen10 X3216 1TB Entry CN Svr

870208-371 HPE MicroSvr Gen10 X3216 1TB Entry AP Svr

873830-421 HPE MicroSvr Gen10 X3216 Entry EU Svr

870210-421 HPE MicroSvr Gen10 X3421 Perf. EU Svr

870210-001 HPE MicroSvr Gen10 X3421 Perf. US Svr LA/US

870210-295 HPE MicroSvr Gen10 X3421 Perf. JP Svr

870210-375 HPE MicroSvr Gen10 X3421 Perf. AP Svr

870210-AA5 HPE MicroSvr Gen10 X3421 Perf. CN Svr

**Purpose:** The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HPE products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

### 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

| Item Description   | Notes   | Quantity of items included in product |
|--|---|---------------------------------------|
| Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)                         | With a surface greater than 10 sq cm  | 1                                     |
| Batteries  | All types including standard alkaline and lithium coin or button style batteries      | 1                                     |
| Mercury-containing components  | For example, mercury in lamps, display backlights, scanner lamps, switches, batteries | 0                                     |
| Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm                      | Includes background illuminated displays with gas discharge lamps                     | 0                                     |
| Cathode Ray Tubes (CRT)  |   | 0                                     |
| Capacitors / condensers (Containing PCB/PCT)   |   | 0                                     |
| Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height |   | 1                                     |
| External electrical cables and cords   |   | 0                                     |
| Gas Discharge Lamps  |   | 0                                     |

| Item Description   | Notes  | Quantity of items included in product |
|--|--|---------------------------------------|
| Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above) |  | 1                                     |
| Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner                                     | Include the cartridges, print heads, tubes, vent chambers, and service stations. | 0                                     |
| Components and waste containing asbestos   |  | 0                                     |
| Components, parts and materials containing refractory ceramic fibers   |  | 0                                     |
| Components, parts and materials containing radioactive substances  |  | 0                                     |

## 2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

| Tool Description | Tool Size (if applicable) |
|------------------|---------------------------|
| Torx Driver      | T15                       |
|                  |                           |
|                  |                           |
|                  |                           |
|                  |                           |

## 3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

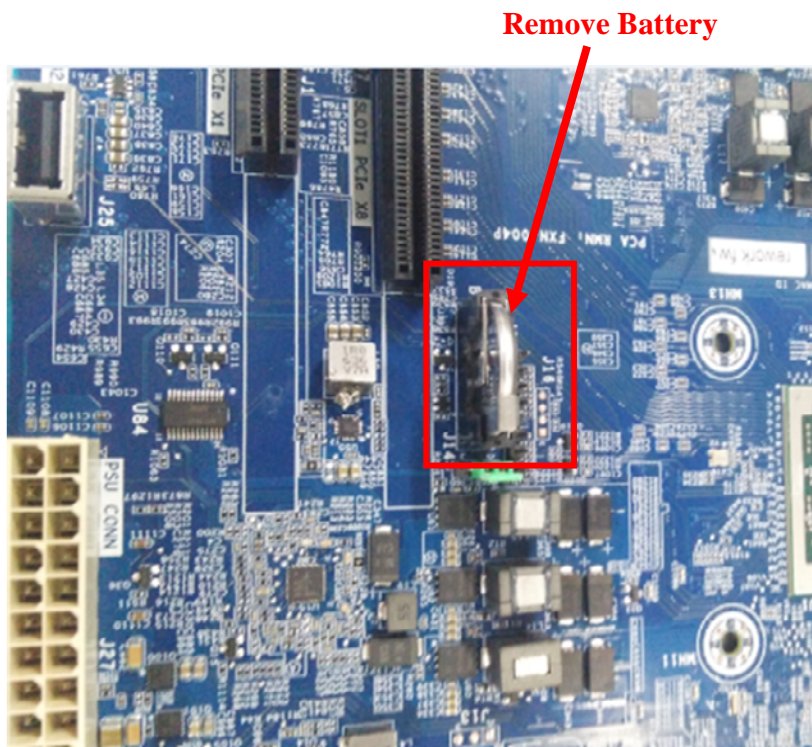
1. System Board Battery – Locate the battery on the system Board, use fingers to remove the battery and dispose of properly.
2. Capacitors →2.5cm – Remove the PSU from the system. Remove the screws securing the top cover, locate the capacitors and use a medium flat head screwdriver to remove them and dispose of properly.
- 3.
- 4.
- 5.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

Attachment 1 – System Battery Location

Attachment 2 – Capacitor Location in PSU

## Attachment 1



## Attachment 2

